

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kenji MORIMOTO et al.

Group Art Unit: 2827

Serial No.: 10/088,479

Examiner: James M. Mitchell

Filed: March 20, 2002

For: FLIP CHIP PACKAGE, CIRCUIT BOARD

THEREOR AND PACKAGING METHOD THEREOF

AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

In response to the Office Action mailed July 8, 2003, please amend the above-identified application as follows: